Reference Module

Preliminary

The Square SE series utilizes Seoul's high performing 3030 LEDs to deliver efficacies up to 190 Lm/W at typical driving currents. This solution features uniformity of light and color and enables easy installation with a Zhaga compatible mounting pattern.

Applications:













Square SE Series







Features:

- · High efficacy, long life
- Optimized for the Book 7 of ZHAGA standard
- 3 SDCM
- ROHS Compliant

Key Applications:

- Troffer Retrofit
- High Bay
- LED Panel
- Channel

Product Selection: SMJD-2316032G-XXN1I_F = 700mA, T_c = 25°C

| ССТ | CRI | Flux | | Dimension | Order Code | |
|------|-----|------|------|--------------|--------------------------------|--------------------------------|
| CCI | CRI | Min. | Тур. | Dimension | Order Code | |
| 3000 | | 2610 | 2760 | | SMJD-2316032G-XXN100C76G038AII | |
| 4000 | 80 | 2890 | 3010 | 121.4 x 49.5 | SMJD-2316032G-XXN100D01E038All | |
| 5000 | | 2690 | 3010 | | | SMJD-2316032G-XXN100D01C038All |

Electro Optical Characteristics: SMJD-2316032G-XXN1I $_F$ = 700mA, T_c = 25°C

| Parameter | Symbol | Value | | | Unit | Remark |
|-------------------------------------|--------------------|-------|------|------|--------|----------|
| i didilietei | | Min. | Тур. | Max. | | |
| Lucia cua Elicu | | 2610 | 2760 | - | - lm | G |
| Luminous Flux | Ф _V [2] | 2890 | 3010 | - | - 1111 | C,E |
| | | 4745 | 5028 | 5311 | | С |
| Correlated Color Temperature [3] | CCT | 3710 | 3985 | 4260 | K | Е |
| · | | 2870 | 3045 | 3220 | | G |
| CRI | Ra | 80 | - | - | - | - |
| Input Voltage | VF | 21.8 | 22.7 | 23.5 | VDC | @700mA |
| Power Consumption | Р | 15.3 | 15.9 | 16.5 | W | €700IIIA |
| Efficiency | LPW | - | 168 | - | - Lm/W | G |
| | LI VV | - | 190 | - | | C,E |

Notes:

- 1 Above data tested with constant typical current at T_c =25 °C.
- 2 Φ_v is the total luminous flux output measured with an integrated sphere.
- 3 Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.
- 4 To use the module properly, recommend to drive the module by a Constant Current Source (CCS). But the Maximum output voltage of the CCS should be limited by referring this sheet.

Absolute Maximum Operating Specification: $T_c = 25^{\circ}C$

| Model | Parameter | Symbol | Unit | Value | Remark |
|--------------------|---------------------------|------------------|------|------------|-----------------|
| | Power Consumption | Р | W | 18.6 | |
| | Forward Voltage | V_{F} | V | 23.2 | |
| | Driving Current (2) | ${ m I}_{\sf F}$ | mA | 800 | |
| SMJD-2316032G-XXN1 | Operating Temperature (3) | T _C | oC. | - 40 ~ 85 | Reference point |
| | Storage Temperature | T_{stg} | oC. | - 40 ~ 100 | With no power |
| | ECD Countries | | 107 | ±8 | IEC Air |
| | ESD Sensitivity | - | KV | ±4 | НВМ |

Notes:

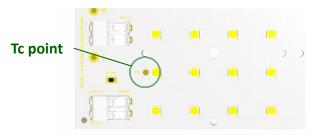
- 1 Above data tested with constant typical current at T_c =25 °C.
- 2 Φ_{v} is the total luminous flux output measured with an integrated sphere.
- 3 Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.
- 4 To use the module properly, recommend to drive the module by a Constant Current Source (CCS). But the Maximum output voltage of the CCS should be limited by referring this sheet.

Notes:

*Colors fully compliant with the CIE requested color temperatures on the following table:

| Correlated Color Temperature | Nominal CCT | сст (к) |
|------------------------------|-------------|------------|
| С | 5000 K | 5028 ± 283 |
| Е | 4000 K | 3985 ± 275 |
| G | 3000 K | 3045 ± 175 |

Illustration: How to predict components temperature



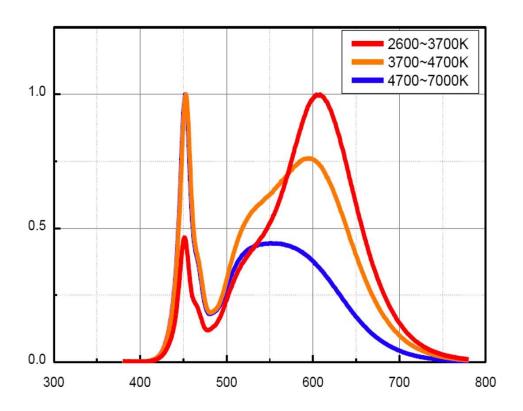
* Recommended Tc Testing point

Notes:

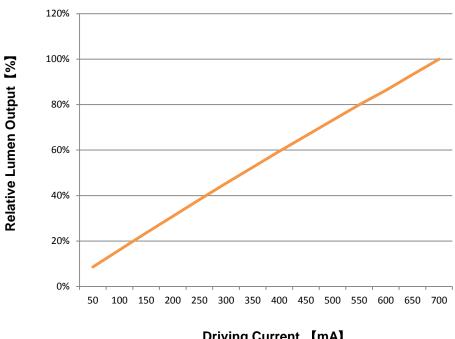
- 1 The modules must be operated within the operating conditions stated in the Absolute Maximum Operating Specifications.
- 2 Please use a Constant Current Source (CCS) to drive the module, the typical V_F of module is 21.8 V_{DC} and $V_{F,MAX}$ is 23.5 V_{DC} respectively.
- 3 Operating temperature was tested at the assigned Tc point on the PCB.
- 4 To ensure the module works properly, $T_{\rm C}$ should refer to "Absolute Maximum Operating Specification".

Relative Spectral Distribution

• Relative Spectral Distribution vs. Wavelength

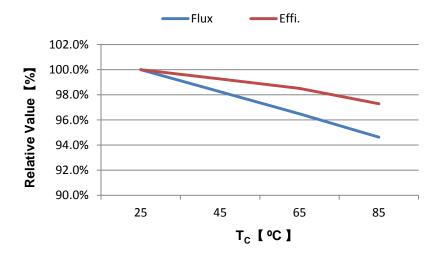


• Scale ratio curve for related lumen output VS driving current, $T_c = 25$ °C



Driving Current [mA]

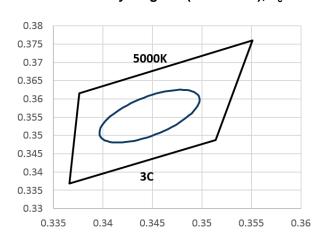
• Flux and Efficacy Versus Temperature at $T_C(at I_F nominal)$



| T _C [°C] | Flux[%] | Efficacy[%] |
|---------------------|---------|-------------|
| 25 | 100 | 100 |
| 45 | 98.2 | 99.3 |
| 65 | 96.5 | 98.5 |
| 85 | 94.6 | 97.3 |

Color Bin Structure

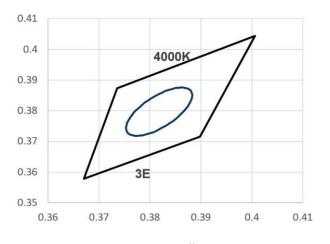
CIE Chromaticity Diagram (Cool white), T_c = 25 °C



5000K 3 Step Ellipse

| | | 3C | | |
|--------|--------|--------|--------|-------|
| x | у | а | b | theta |
| 0.3447 | 0.3553 | 0.0081 | 0.0035 | 60 |

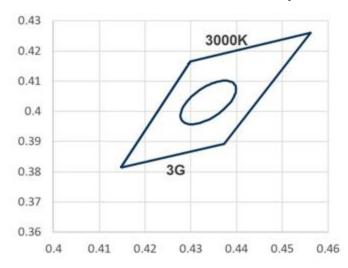
CIE Chromaticity Diagram (Nature white), T_c = 25 °C



4000K 3 Step Ellipse

| | | 3E | | |
|--------|--------|--------|-------|-------|
| x | у | а | b | theta |
| 0.3818 | 0.3797 | 0.0094 | 0.004 | 53 |

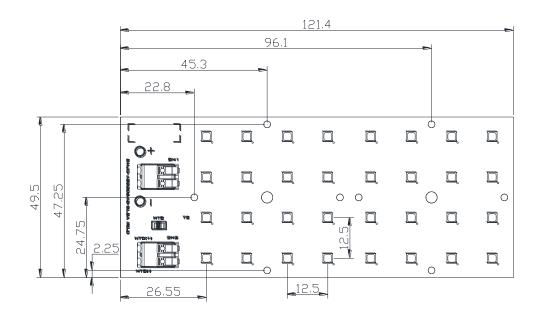
CIE Chromaticity Diagram (Warm white), T_c = 25 °C



3000K 3 Step Ellipse

| | | 3G | | |
|--------|--------|--------|--------|-------|
| x | у | а | b | theta |
| 0.4338 | 0.4030 | 0.0085 | 0.0041 | 53 |

Mechanical Dimensions

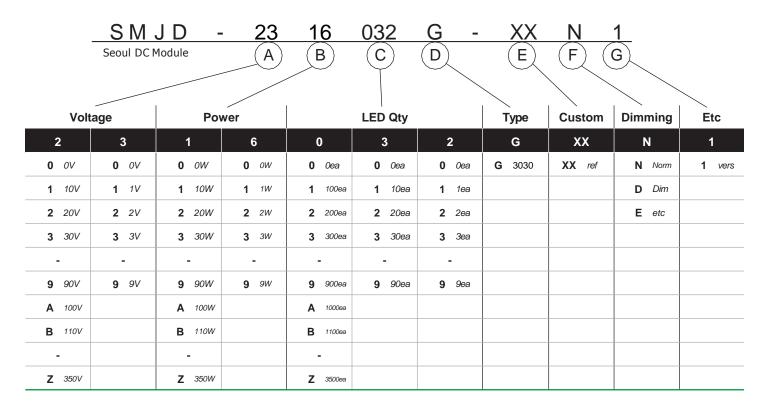




| Dimension | Specification | Tolerance | Unit | |
|---------------|---------------|-----------|------|--|
| Module Length | 121.4 | ±0.3 | | |
| Module Width | 49.5 | ±0.3 | mm | |
| Module Height | 6.1 | ±0.3 | | |
| PCB Thickness | 1.6 | ±0.2 | | |

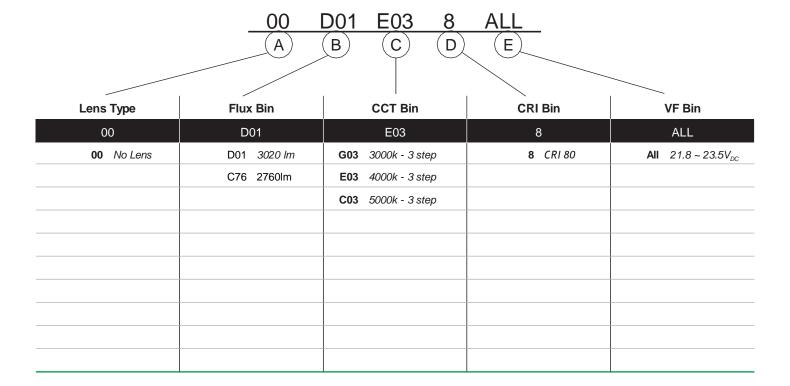
Product Nomenclature:

*Please refer to the following chart

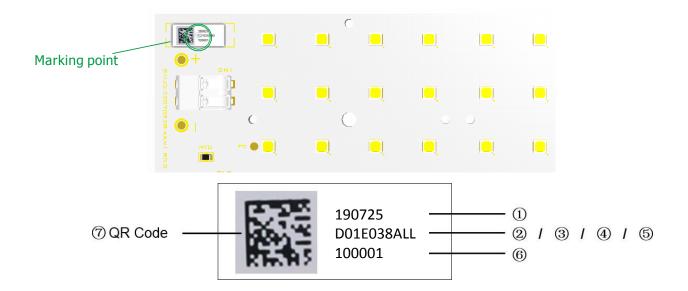


Product Nomenclature: Binning

*Please refer to the following chart



Marking Information



| No. | Item | Inforn | nation | Digits | Remark |
|-----|---------------------|---------------|---------------|---------|-----------------------------|
| 1 | Date | YYMMDD | | 6 Digit | SMT date |
| 2 | Flux ⁽¹⁾ | D01 | | 3 Digit | D01=3010lm |
| 3 | CCT | X03 | 3-step Mixing | 3 Digit | X=C,E,G |
| 4 | CRI | 8 | 8 | | CRI=80 |
| (5) | V_{F} | ALL | | 3 Digit | |
| 6 | Lot No. | • | 1 | 1 Digit | 0~9,A~Z |
| | Sequence No. | 00001 5 Digit | | 5 Digit | 00001 ~ 99999 |
| 7 | QR Code | QR (| Code | - | Please refer to below table |

Note:

*Flux Bin - please refer to following chart for definitions:

Flux Bin Definitions

| Symbol | lm | Symbol | lm | Symbol | lm | Symbol | lm |
|--------|------|--------|------|--------|------|--------|-------|
| A50 | 500 | D50 | 3500 | G50 | 6500 | J50 | 9500 |
| B50 | 1500 | E50 | 4500 | H50 | 7500 | K20 | 10200 |
| C50 | 2500 | F50 | 5500 | 150 | 8500 | L00 | 11000 |

Module QR Code Information

| QR Code Information | | | | | | | | | |
|---------------------|---------|----------|-------------|-------------------|-------------|-------------|----------|-------------|--|
| Items | Factory | SAP Code | SMT Date | MP Information | Line No. | Lot No. | Product | Note | |
| Digits | 1 Digit | 7 Digits | 6 Digits | 10 Digits | 1 Digit | 1 Digit | 5 Digits | In Total 31 | |
| Information | * | ***** | YYMMDD | D01E03 8ALL | 1~9, A~Z | 1~9, A~Z | 00001 | Digits | |

Notes:

- 1 QR coded information shall include the fields described in the table above.
- 2 Minimum size of QR code shall be 4.5 mm x 4.5 mm and a minimum QR codegrade of 'C'.

 *'A' grading is preferred.
- 3 If the component is small to have a full label, it is acceptable to have only the QR code in minimum size of 6 mm by 6 mm printed on a label.
- 4 QR Code Example: ******190425D01E038ALL11100001

Label Information

| PO Number | XXXXXX(1) IIIII II IIII III | | | |
|----------------------|---|--|--|--|
| Supplier Part Number | SMJD-2316032G-XXN100D01E038ALL ⁽²⁾ | | | |
| Bin Code | D01E038ALL ⁽³⁾ | | | |
| Quantity | XX | | | |
| Country of Origin | XX ⁽⁴⁾ | | | |
| Date Code | YYYYWW (5) | | | |
| Lot Code | YYMDDXXXXX- XXXXXXX ⁽⁶⁾ | | | |
| SEOUL | SEOUL SEMICONDUCTOR CO.,LTD. | | | |

Notes:

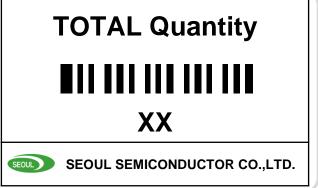
- [1] This is customer's PO Number
- [2] Please refer to SPEC page 10 (30 digit code)
- [3] Please refer to SPEC page 10
- [4] Country of Origin: 2 digit code . For example : Chinese Code: CN
- [5] Date Code: YYYYWW: Packing Date: Year + Week
- [6] Lot Code:

Initial of manufacture is refer to the 2D code rule.

YYMDD: Packing Date (Oct.: A, Nov.: B, Dec.: C)

X : Initial of Manufacturer XXXX : Sealing Pack No. XXXXXXX : SSC SAP Code

[7] It is attached to the top left corner of the box.

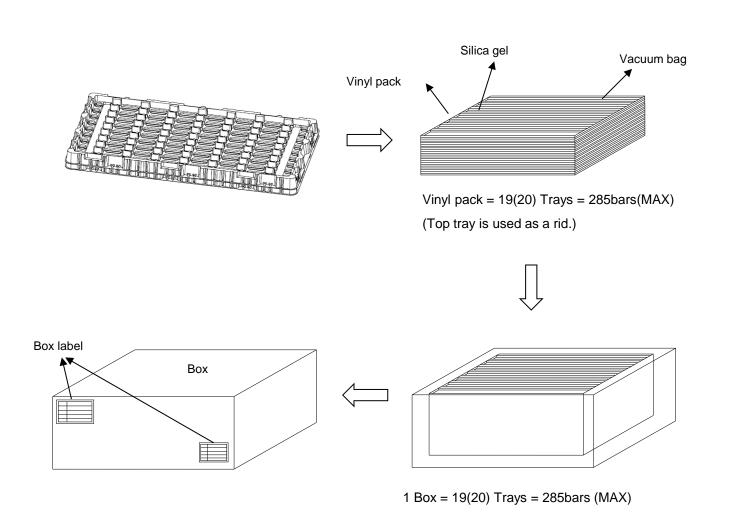


Notes:

 $\[1\]$ Attached to the bottom right corner of the carton box.

Packaging Specification

| Model | Tray | | Вох | | Pallet | |
|--------------------|----------------|--------------------|-----------------|--------------------|-------------|--------------------|
| | Size (mm) | Q'ty per tray (ea) | Size (mm) | Q'ty per tray (ea) | Saze (mm) | Q'ty per tray (ea) |
| SMJD-2316032G-XXN1 | 480 x 380 x 15 | 15 | 495 x 395 x 242 | 285 | 1300 x 1130 | 6840 |



Storage before use

- . When storing devices for a long period of time before usage, please following these guidelines.
 - The devices should be stored in the anti-static bag that itwas shipped in from Seoul-Semiconductor with opening
 - If the anti-static bag has been opened, re-seal preventing air and moisture from being present in the bag.



SEOUL SEMICONDUCTOR

Company Information

Seoul Semiconductor (SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotice, general illumination/ lighting, appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", deep UV LEDs, "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology", a proprietary family of high-voltage LEDs. The company's broad product portfolio includes a wide array of package and device choices such as Acrich, high-brightness LEDs, mid-power LEDs, side-view LEDs, through-hole type LED lamps, custom displays, and sensors. The company is vertically integrated from epitaxial growth and chip manufacture in it's fully owned subsidary, Seoul Viosys, through packaged LEDs and LED modules in three Seoul Semiconductor manufacturing facilities. Seoul Viosys also manufactures a wide range of unique deep-UV wavelength devices.

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